NCE1810AK

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE1810AK uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

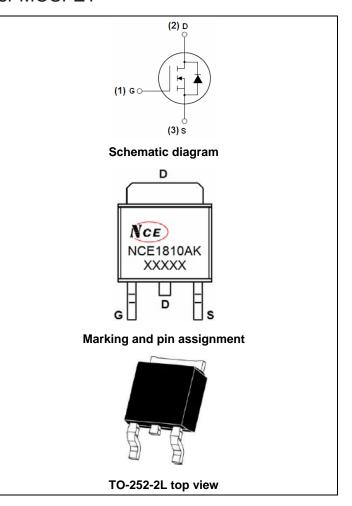
General Features

- V_{DS} =180V, I_{D} =10A $R_{DS(ON)}$ <240mΩ @ V_{GS} =10V (Typ : 200mΩ)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE1810AK	NCE1810AK	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	180	V
Gate-Source Voltage	V _G S	±20	V
Drain Current-Continuous	I _D	10	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	7	А
Pulsed Drain Current	I _{DM}	40	Α
Maximum Power Dissipation	P _D	55	W
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	R _{eJC}	2.3	°C/W
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Electrical Characteristics (T_C=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	180	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =180V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)	On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.7	2.5	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10 V , I_D =5 A	-	200	240	mΩ	
Forward Transconductance	g FS	V _{DS} =5V,I _D =5A	3	-	-	S	
Dynamic Characteristics (Note4)	•						
Input Capacitance	C _{lss}	\/ -25\/\/ -0\/		900		PF	
Output Capacitance	Coss	V_{DS} =25V, V_{GS} =0V, F=1.0MHz		160		PF	
Reverse Transfer Capacitance	C _{rss}	r=1.0lvln2		110		PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	8	-	nS	
Turn-on Rise Time	t _r	V_{DD} =100 V , I_{D} =5 A	-	13	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =5 Ω	-	25	-	nS	
Turn-Off Fall Time	t _f		-	8	-	nS	
Total Gate Charge	Qg	\/ 400\/ 54	-	24	-	nC	
Gate-Source Charge	Q _{gs}	V _{DS} =100V,I _D =5A,	-	8	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	5	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =5A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	10	Α	

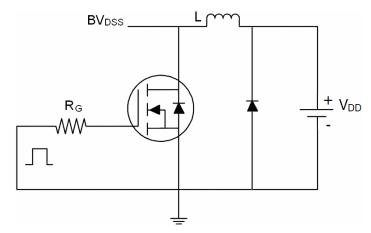
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

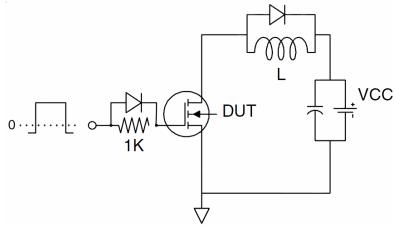


Test Circuit

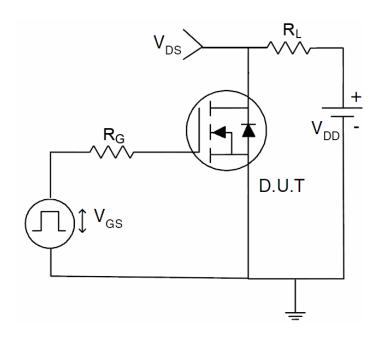
1) E_{AS} test Circuit



2) Gate charge test Circuit



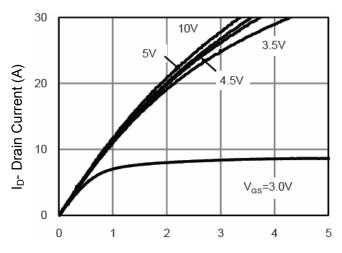
3) Switch Time Test Circuit





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Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V) **Figure 1 Output Characteristics**

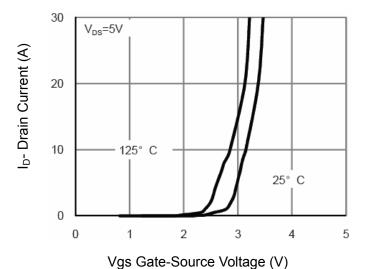


Figure 2 Transfer Characteristics

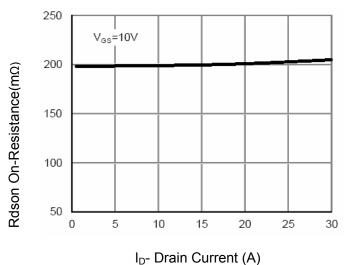


Figure 3 Rdson- Drain Current

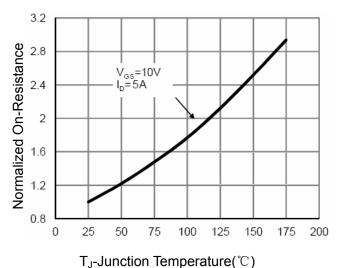


Figure 4 Rdson-JunctionTemperature

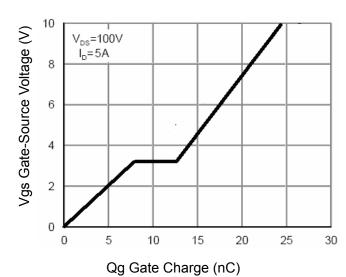


Figure 5 Gate Charge

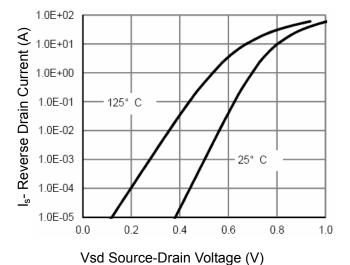
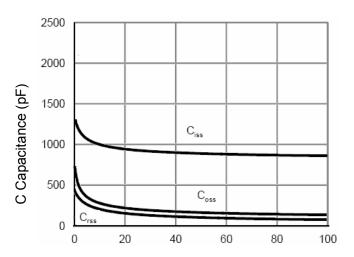


Figure 6 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds

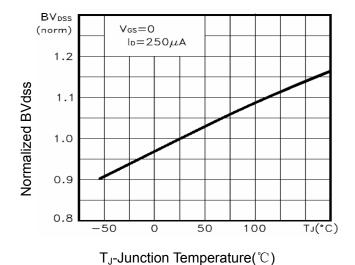


Figure 9 BV_{DSS} vs Junction Temperature

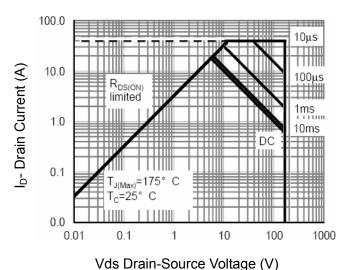
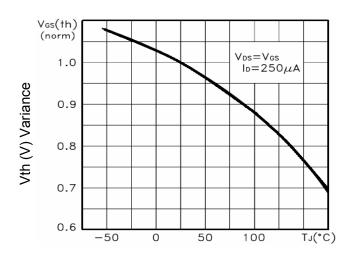


Figure 8 Safe Operation Area



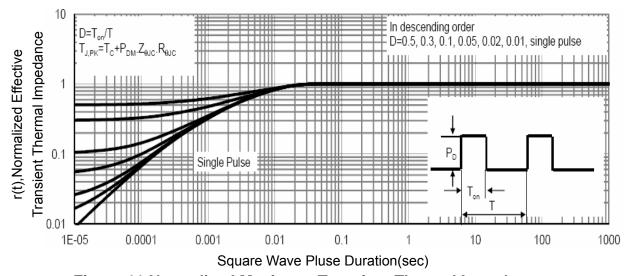
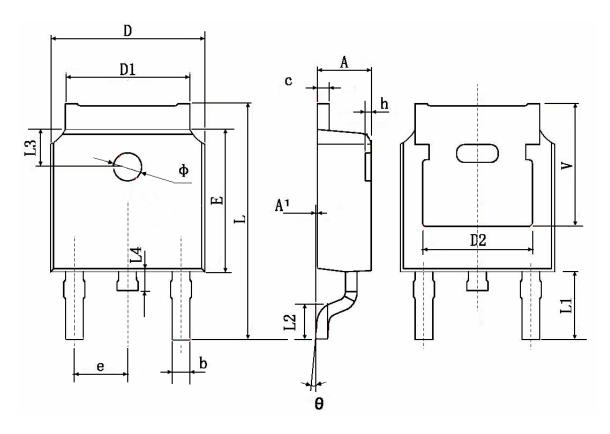


Figure 11 Normalized Maximum Transient Thermal Impedance



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TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.48	3 TYP.	0.190	0 TYP.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.90	0 TYP.	0.114	0.114 TYP.	
L2	1.400	1.700	0.055	0.067	
L3	1.60	0 TYP.	0.063	TYP.	
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.35	0 TYP.	0.211 TYP.		



http://www.ncepower.com

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